

	Type	L #	Hits	Search Text	DBs
1	BRS	L1	2208	257/415,417-420.ccls.	US- PGPUB; USPAT; EPO; JPO; DERWEN T
2	BRS	L2	243	L1 and groove\$	US- PGPUB; USPAT; EPO; JPO; DERWEN T
3	BRS	L9	1039	L1 not (L3 or L2)	US- PGPUB; USPAT; USOCR
4	BRS	L10	788	L1 and (torsion\$ or torque or beam or cantilevel or spring or support or mass or movable)	US- PGPUB; USPAT; USOCR
5	BRS	L12	897	257/417.ccls.	US- PGPUB; USPAT; EPO; JPO; DERWEN T
6	BRS	L16	390	"x-shaped" near3 (support or beam)	US- PGPUB; USPAT; USOCR
7	BRS	L18	69032	(concave or groove) near6 (support or beam)	US- PGPUB; USPAT; USOCR

	Type	L #	Hits	Search Text	DBs
8	BRS	L19	11892	L18 and (semiconductor or (micromechanical) or MEMS)	US- PGPUB; USPAT; USOCR
9	BRS	L20	38095	(concave or groove) near3 (support or beam)	US- PGPUB; USPAT; USOCR
10	BRS	L21	6656	L20 and (semiconductor or (micromechanical) or MEMS)	US- PGPUB; USPAT; USOCR
11	BRS	L28	40508	("257"/\$.ccls. or "438"/\$.ccls.) and (substrate with include with layer)	US- PGPUB; USPAT; EPO; JPO; DERWEN T
12	BRS	L29	291	("257"/\$.ccls. or "438"/\$.ccls.) and (substrate with include with layer with (mean or intend\$))	US- PGPUB; USPAT; EPO; JPO; DERWEN T
13	BRS	L31	0	("257"/\$.ccls. or "438"/\$.ccls.) and (substrate with include with layer with other with define\$)	US- PGPUB; USPAT; EPO; JPO; DERWEN T

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14	BRS	L32	1911	("257"/\$.ccls. or "438"/\$.ccls.) and (substrate with include with layer with define\$)	US- PGPUB; USPAT; EPO; JPO; DERWEN T
15	BRS	L3	70	L1 and concave	US- PGPUB; USPAT; EPO; JPO; DERWEN T
16	IS&R	L4	9	("5982521").PN.	US- PGPUB; USPAT; EPO; JPO; DERWEN T
17	BRS	L5	58	L3 not L2	US- PGPUB; USPAT; EPO; JPO; DERWEN T
18	BRS	L7	5	("5208880" "5912608" "5966009" "6122089" "6404313").PN.	US- PGPUB; USPAT; USOCR
19	BRS	L8	2	("4421381" "5378653").PN.	US- PGPUB; USPAT; USOCR

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20	IS&R	L14	2	("6632698").PN.	US- PGPUB; USPAT; EPO; JPO; DERWEN T
21	BRS	L15	9	("6000280" "6010919" "6073484" "6093330" "6117701" "6308631" "6388789" "6445106" "6462391").PN.	US- PGPUB; USPAT; USOCR
22	BRS	L17	16	L16 and semiconductor	US- PGPUB; USPAT; USOCR
23	BRS	L23	20	L21 and 257/415-420.ccls.	US- PGPUB; USPAT; USOCR
24	BRS	L24	5	("5503017" "5504356" "5572057" "5627397" "5895851").PN.	US- PGPUB; USPAT; USOCR
25	BRS	L26	90	"257"/\$.ccls. and nanopore	US- PGPUB; USPAT; EPO; JPO; DERWEN T
26	BRS	L30	96	("257"/\$.ccls. or "438"/\$.ccls.) and (substrate with include with layer with other)	US- PGPUB; USPAT; EPO; JPO; DERWEN T

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27	BRS	L33	65	("257"/\$.ccls. or "438"/\$.ccls.) and (substrate with include with layer with define\$ with underlying)	US- PGPUB; USPAT; EPO; JPO; DERWEN T
28	BRS	L34	5	("4236137" "4467656" "4543457" "4902861" "5028749").PN.	US- PGPUB; USPAT; USOCR
29	BRS	L35	44	("3672985" "4437226" "4472239" "4522682" "4648173" "4649625" "4653326" "4670092" "4682503" "4685198" "4740410" "4776924" "4783237" "4783821" "4816884" "4833516" "4845048" "4853348" "4914628" "4980317" "4988637" "5008214" "5068203" "5072288" "5106775" "5198390" "5235187" "5264716" "5346834" "5360758" "5393375" "5426070" "5443992" "5466625" "5466636" "5508219" "5528062" "5547903" "5581101" "5614431" "5643815" "5719073" "5846849").PN.	US- PGPUB; USPAT; USOCR
30	BRS	L27	109	257/415,417-420.ccls. and (beam or cantilever) and (single adj crystal adj (Si or silicon))	US- PGPUB; USPAT; EPO; JPO; DERWEN T

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31	BRS	L6	231	L2 not L3	US- PGPUB; USPAT; EPO; JPO; DERWEN T
32	BRS	L22	477	L21 and "257"/\$.ccls.	US- PGPUB; USPAT; USOCR
33	BRS	L13	786	L12 not (L3 or L2)	US- PGPUB; USPAT; EPO; JPO; DERWEN T
34	BRS	L25	1422	L1 not L13	US- PGPUB; USPAT; EPO; JPO; DERWEN T
35	BRS	L11	2208	257/415,417-420.ccls.	US- PGPUB; USPAT; EPO; JPO; DERWEN T